

Date: - 20 Nov, 2001

Data Sheet Issue:- 1

Phase Control Thyristor Types N2500VC120 to N2500VC160

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V_{DRM}	Repetitive peak off-state voltage, (note 1)	1200-1600	V
V_{DSM}	Non-repetitive peak off-state voltage, (note 1)	1200-1600	V
V_{RRM}	Repetitive peak reverse voltage, (note 1)	1200-1600	V
V_{RSM}	Non-repetitive peak reverse voltage, (note 1)	1300-1700	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{T(AV)}	Mean on-state current. T _{sink} =55°C, (note 2)	2500	Α
I _{T(AV)}	Mean on-state current. T _{sink} =85°C, (note 2)	1684	Α
I _{T(AV)}	Mean on-state current. T _{sink} =85°C, (note 3)	992	Α
I _{T(RMS)}	Nominal RMS on-state current. T _{sink} =25°C, (note 2)	4985	Α
I _{T(d.c.)}	D.C. on-state current. T _{sink} =25°C, (note 4)	4199	А
I _{TSM}	Peak non-repetitive surge t _p =10ms, V _{rm} =0.6V _{RRM} , (note 5)	37000	Α
I _{TSM2}	Peak non-repetitive surge t _p =10ms, V _{rm} ≤10V, (note 5)	45000	Α
l ² t	I ² t capacity for fusing t _p =10ms, V _{rm} =0.6V _{RRM} , (note 5)	6.85×10 ⁶	A ² s
l ² t	I ² t capacity for fusing t _p =10ms, V _{rm} ≤10V, (note 5)	10.1×10 ⁶	A ² s
al: /al#	Maximum rate of rise of on-state current (repetitive), (Note 6)	150	A/µs
di _⊤ /dt	Maximum rate of rise of on-state current (non-repetitive), (Note 6)	300	A/µs
V_{RGM}	Peak reverse gate voltage	5	V
P _{G(AV)}	Mean forward gate power	5	W
P _{GM}	Peak forward gate power	30	W
V_{GD}	Non-trigger gate voltage, (Note 7)	0.25	V
T _{HS}	Operating temperature range	-40 to +125	°C
T _{stg}	Storage temperature range	-40 to +150	°C

Notes:

- 1) De-rating factor of 0.13% per °C is applicable for T_i below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 125°C T_i initial.
- 6) $V_D=67\% V_{DRM}$, $I_{TM}=1000A$, $I_{FG}=2A$, $t_r \le 0.5 \mu s$, $T_{case}=125$ °C.
- 7) Rated V_{DRM}.

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V _{TM}	Maximum peak on-state voltage	-	-	1.28	I _{TM} =3220A	V
V_0	Threshold voltage	-	-	0.88		V
r _S	Slope resistance	-	-	0.124		mΩ
dv/dt	Critical rate of rise of off-state voltage	200	-	-	V _D =80% V _{DRM} , linear ramp, Gate O/C	V/μs
I _{DRM}	Peak off-state current	-	-	150	Rated V _{DRM}	mA
I _{RRM}	Peak reverse current	-	-	150	Rated V _{RRM}	mA
V _{GT}	Gate trigger voltage	-	-	3.0	T 25°C V 40V L 24	V
I _{GT}	Gate trigger current	-	-	300	$T_{j}=25$ °C, $V_{D}=10$ V, $I_{T}=3$ A	mA
I _H	Holding current	-	-	1000	T _j =25°C	mA
t _{gd}	Gate controlled turn-on delay time	-	1.0	2.0	V _D =67%V _{DRM} , I _{TM} =2000A, di/dt=10A/µs,	
t gt	Turn-on time	-	1.5	2.5	I _{FG} =2A, t _r =0.5μs, T _j =25°C	μs
Q _{rr}	Recovered Charge	-	2200	-		μC
Q _{ra}	Recovered Charge, 50% chord	-	1300	1800	 I _{TM} =1000A, t _p =1000μs, di/dt=10A/μs,	μC
I _{rm}	Reverse recovery current	-	100	-	V _r =50V	Α
t _{rr}	Reverse recovery time, 50% chord	-	20.0	-		μs
	Turn off time	-	500	800	I _{TM} =1000A, t _p =1000μs, di/dt=10A/μs, V _r =50V, V _{dr} =33%V _{DRM} , dV _{dr} /dt=20V/μs	
tq	Turn-off time	-	800	1200	I _{TM} =1000A, t _p =1000μs, di/dt=10A/μs, V _r =50V, V _{dr} =33%V _{DRM} , dV _{dr} /dt=200V/μs	μs
0	The word was interesting to be actively	-	-	0.017	Double side cooled	K/W
$R_{th(j-hs)}$	Thermal resistance, junction to heatsink	-	-	0.034	Single side cooled	K/W
F	Mounting force	27	-	34		kN
W_t	Weight		1.0	-		kg

Notes: -

¹⁾ Unless otherwise indicated T_j=125°C.

Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade	$V_{DRM} V_{DSM} V_{RRM} V$	V _{RSM} V	V _D V _R DC V
12	1200	1300	810
14	1400	1500	930
16	1600	1700	1040

2.0 Extension of Voltage Grades

This report is applicable to other and higher voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T_i below 25°C.

4.0 Repetitive dv/dt

Standard dv/dt is 1000V/µs.

5.0 Rate of rise of on-state current

The maximum un-primed rate of rise of on-state current must not exceed 300A/µs at any time during turnon on a non-repetitive basis. For repetitive performance, the on-state rate of rise of current must not exceed 150A/µs at any time during turn-on. Note that these values of rate of rise of current apply to the total device current including that from any local snubber network.

6.0 Gate Drive

The recommended pulse gate drive is 30V, 15Ω with a short-circuit current rise time of not more than 0.5µs. This gate drive must be applied when using the full di/dt capability of the device.

The pulse duration may need to be configured according to the application but should be no shorter than 20µs, otherwise an increase in pulse current may be needed to supply the necessary charge to trigger.

7.0 Computer Modelling Parameters

7.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_0 + \sqrt{{V_0}^2 + 4 \cdot \textit{ff}^2 \cdot \textit{r}_s \cdot W_{AV}}}{2 \cdot \textit{ff}^2 \cdot \textit{r}_s} \qquad W_{AV} = \frac{\Delta T}{R_{th}}$$
 and:
$$\Delta T = T_{j \max} - T_{Hs}$$

Where V_0 =0.88V, r_s =0.124m Ω ,

 R_{th} = Supplementary thermal impedance, see table below.

ff = Form factor, see table below.

Supplementary Thermal Impedance							
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave Double Side Cooled	0.0263	0.0237	0.022	0.0207	0.0192	0.0179	0.0171
Square wave Single Side Cooled	0.0438	0.0418	0.040	0.038	0.0367	0.0357	0.034
Sine wave Double Side Cooled	0.0238	0.021	0.0196	0.0187	0.0169		
Sine wave Single Side Cooled	0.0426	0.0396	0.0382	0.0373	0.0356		

		Form Fa	ctors				
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave	3.46	2.45	2	1.73	1.41	1.15	1
Sine wave	3.98	2.78	2.22	1.88	1.57		

7.2 Calculating V_T using ABCD Coefficients

The on-state characteristic I_T vs. V_T, on page 5 is represented in two ways;

- the well established V₀ and r_s tangent used for rating purposes and (i)
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for V_T in terms of I_T given below:

$$V_T = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for V_T agree with the true device characteristic over a current range, which is limited to that plotted.

125°C Coefficients						
A 0.592114202						
В	-7.608075×10 ⁻³					
С	C 6.807×10 ⁻⁵					
D	9.342666×10 ⁻³					

7.3 D.C. Thermal Impedance Calculation

$$r_{t} = \sum_{p=1}^{p=n} r_{p} \cdot \left(1 - e^{\frac{-t}{\tau_{p}}}\right)$$

Where p = 1 to n, n is the number of terms in the series and:

- t : Duration of heating pulse in seconds.
- r, =Thermal resistance at time t.
- r_p =Amplitude of p_{th} term.
- τ_p =Time Constant of r_{th} term.

D.C. Double Side Cooled							
Term	Term 1 2 3 4						
r_p	8.74×10 ⁻³	5.08×10 ⁻³	1.80×10 ⁻³	1.54×10 ⁻³			
$ au_{ m p}$	1.328	0.157	0.0242	2.3×10 ⁻³			

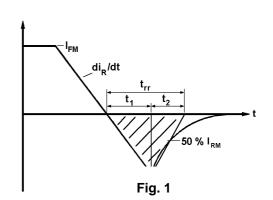
D.C. Single Side Cooled									
Term	Term 1 2 3 4 5 6 7								
r_p	0.0204	4.47×10 ⁻³	2.66×10 ⁻³	4.62×10 ⁻³	1.50×10 ⁻³	1.08×10 ⁻³	1.29×10 ⁻³		
$ au_{\scriptscriptstyle \mathcal{D}}$	9.877	5.385	0.781	0.161	0.0524	0.0106	1.77×10 ⁻³		

8.0 Reverse recovery ratings

- (i) Q_{ra} is based on 50% I_{rm} chord as shown in Fig. 1.
- (ii) Q_{rr} is based on a 150μs integration time.

i.e.
$$Q_{rr} = \int_{0}^{150 \mu s} i_{rr}.dt$$
 $K \ Factor = \frac{t1}{t2}$

(iii)
$$K Factor = \frac{t1}{t2}$$



Curves

Figure 1 - On-state characteristics of Limit device

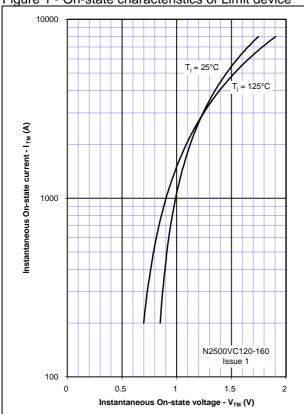


Figure 2 - Transient Thermal Impedance

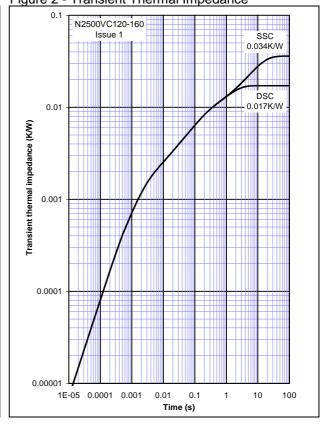


Figure 3 - Gate Characteristics - Trigger Limits

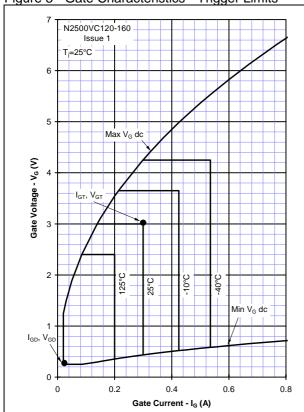
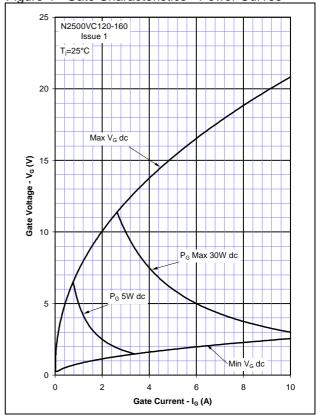
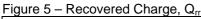


Figure 4 - Gate Characteristics - Power Curves





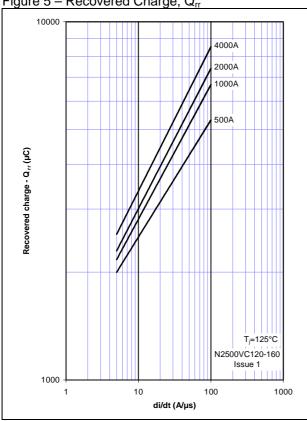
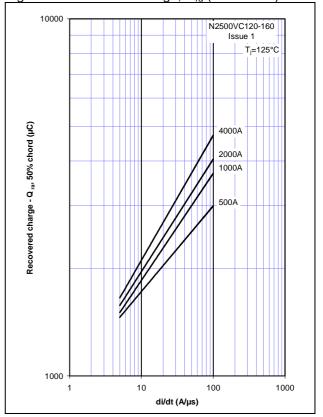


Figure 6 – Recovered charge, Q_{ra} (50% chord)



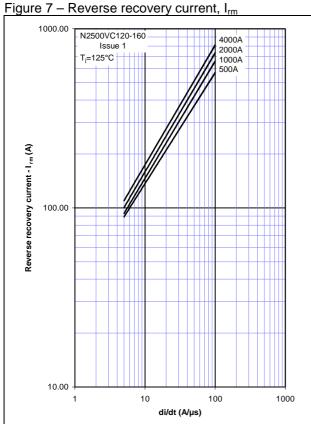


Figure 8 – Reverse recovery time, t_{rr} (50% chord)

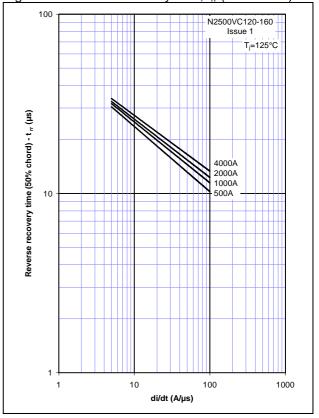


Figure 9 – On-state current vs. Power dissipation – Double Side Cooled (Sine wave)

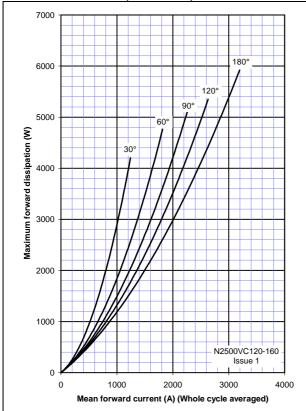


Figure 10 – On-state current vs. Heatsink temperature - Double Side Cooled (Sine wave)

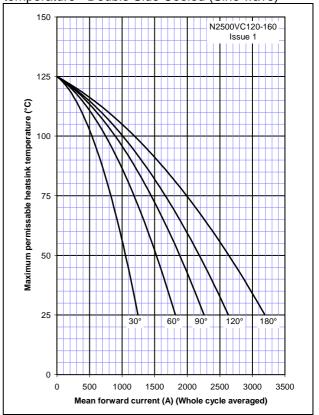


Figure 11 – On-state current vs. Power dissipation – Double Side Cooled (Square wave)

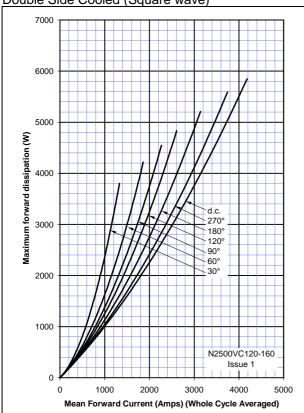


Figure 12 – On-state current vs. Heatsink temperature - Double Side Cooled (Square wave)

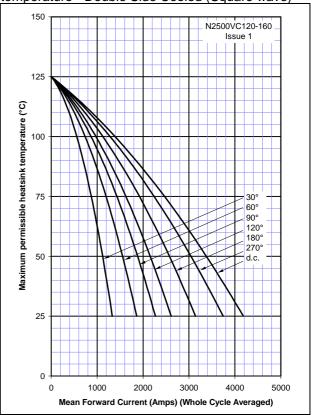


Figure 13 – On-state current vs. Power dissipation – Single Side Cooled (Sine wave)

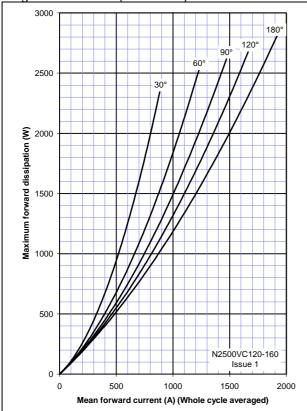


Figure 14 – On-state current vs. Heatsink temperature - Single Side Cooled (Sine wave)

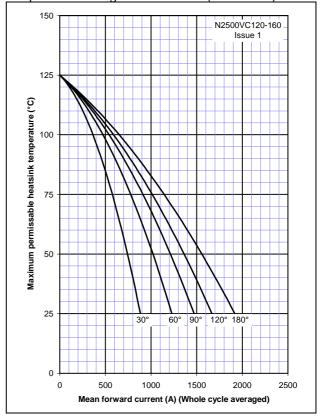


Figure 15 – On-state current vs. Power dissipation – Single Side Cooled (Square wave)

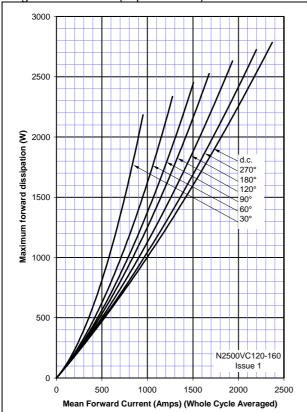
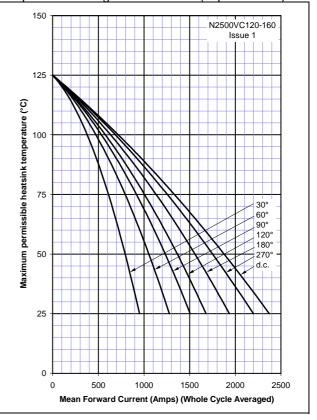
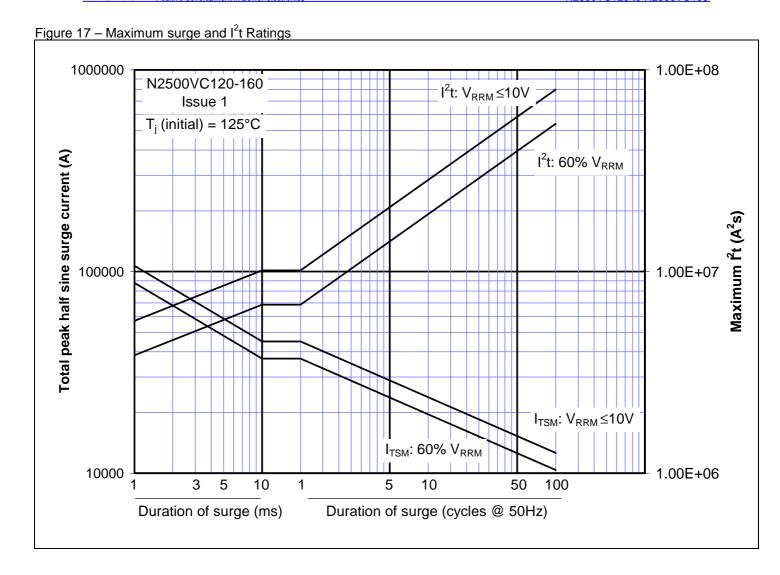
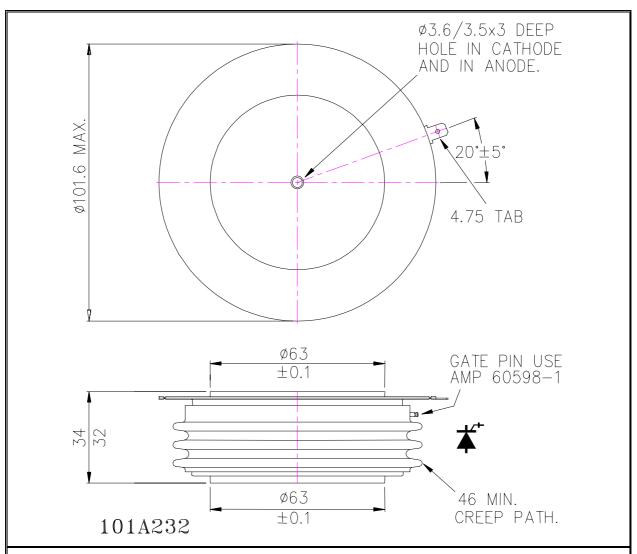


Figure 16 – On-state current vs. Heatsink temperature - Single Side Cooled (Square wave)





Outline Drawing & Ordering Information



ORDERING INFORMATION

(Please quote 10 digit code as below)

(1 3 ,								
N2500	VC	* *	0					
Fixed Type Code	Fixed Outline Code	Voltage Code 12-16	Fixed turn-off time code					

Typical order code: N2500VC120 - 1200V V_{DRM}/V_{RRM}, 34mm clamp height capsule.

WESTCODE

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